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Vishay Semiconductors

RoHS

HALOGEN FREE

GREEN

IR Receiver Modules for Remote Control Systems



MECHANICAL DATA

Pinning:

1, 4 = GND, $2 = V_S$, 3 = OUT

ORDERING CODE

Taping:

TSOP75...TT - top view taped TSOP75...TR - side view taped

FEATURES

- Very low supply current
- · Photo detector and preamplifier in one package
- Compatible also with short burst dataformats
- Supply voltage: 2.5 V to 5.5 V
- · Improved immunity against ambient light
- · Capable of side or top view
- Two lenses for high sensitivity and wide receiving angle
- Insensitive to supply voltage ripple and noise
- Narrow optical filter to reduce interference from plasma TV emissions
- Material categorization: For definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION

The TSOP753.., TSOP755.. series are a two lens miniaturized receiver module for infrared remote control systems. One PIN diode per lens and a preamplifier are assembled on a leadframe, the epoxy lens cap is designed as an IR filter.

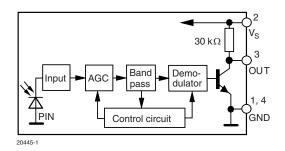
The demodulated output signal can be directly connected to a microprocessor for decoding. The TSOP753.. is optimized to better suppress spurious pulses from energy saving lamps. The TSOP755.. has an excellent noise suppression. It is immune to dimmed LCD backlighting and any fluorescent lamps. AGC3 and AGC5 may also suppress some data signals in case of continuous transmission.

This component has not been qualified according to automotive specifications.

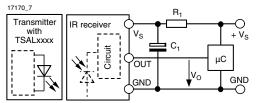
PARTS T	ABLE			
AGC		NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5	
	30 kHz	TSOP75330	TSOP75530	
Carrier frequency	33 kHz	TSOP75333	TSOP75533	
	36 kHz	TSOP75336 (1)(2)	TSOP75536 (1)(2)	
	38 kHz	TSOP75338 (3)(4)(5)(6)	TSOP75538 (3)(4)(5)	
	40 kHz	TSOP75340	TSOP75540	
	56 kHz	TSOP75356	TSOP75556	
Package		Heimo	dall	
Pinning		1, 4 = GND, 2 = V _S , 3 = OUT		
Dimensions (mm)		6.8 W x 3.0 H x 3.2 D		
Mounting		SMD		
Application		Remote control		
Best remote control code		(1) MCIR (2) RCMM (3) Mitsubishi (4) RECS-80 Code (5) r-map (6) XMP-1, XMP-2		



BLOCK DIAGRAM



APPLICATION CIRCUIT



The external components R_1 and C_1 are optional to improve the robustness against electrical overstress (typical values are $R_1=100~\Omega,~C_1=0.1~\mu\text{F}).$ The output voltage V_O should not be pulled down to a level

below 1 V by the external circuit.

The capacitive load at the output should be less than 2 nF.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V _S	-0.3 to +6	V
Supply current		I _S	3	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		I _O	5	mA
Junction temperature		T _j	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND	OPTICAL CHARACTERISTICS (T _{amb} = 25	IARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.5		5.5	V
Cumply ourrent	$E_{V} = 0, V_{S} = 3.3 \text{ V}$	I _{SD}	0.27	0.35	0.45	mA
Supply current	$E_v = 40 \text{ klx, sunlight}$	I _{SH}		0.45		mA
Transmission distance	$E_V = 0$, test signal see fig. 1, IR diode TSAL6200, $I_F = 200 \text{ mA}$	d		45		m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2$, test signal see fig. 1	V _{OSL}			100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - 5/ f_o < t_{po} < t_{pi} + 6/ f_o , test signal see fig. 1	E _{e min.}		0.12	0.25	mW/m²
Maximum irradiance	t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see fig. 1	E _{e max.}	30			W/m ²
Directivity	Angle of half transmission distance	Ψ1/2		± 50		deg

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

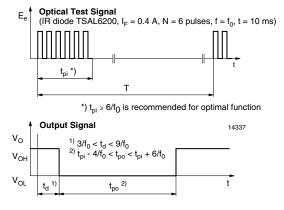


Fig. 1 - Output Active Low

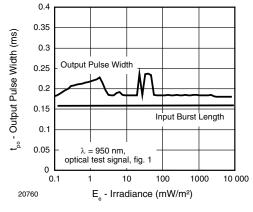


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

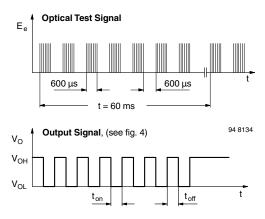


Fig. 3 - Output Function

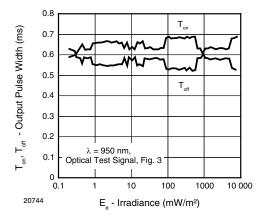


Fig. 4 - Output Pulse Diagram

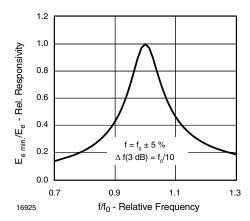


Fig. 5 - Frequency Dependence of Responsivity

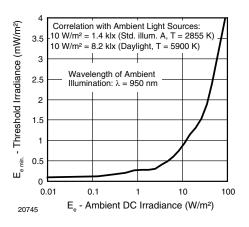


Fig. 6 - Sensitivity in Bright Ambient

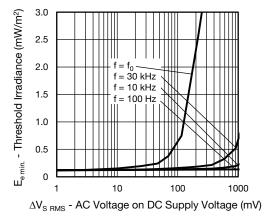


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

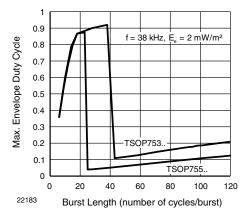


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

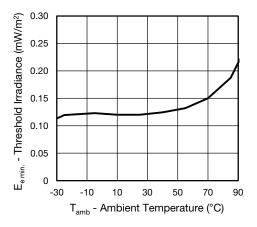


Fig. 9 - Sensitivity vs. Ambient Temperature

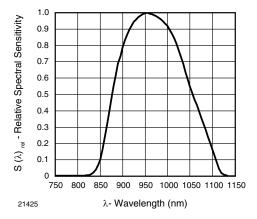


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

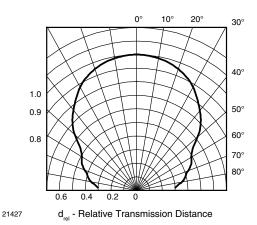


Fig. 11 - Horizontal Directivity

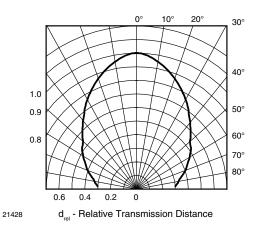


Fig. 12 - Vertical Directivity

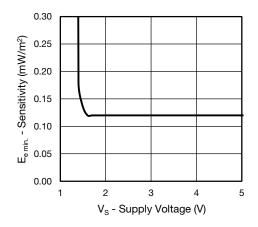


Fig. 13 - Sensitivity vs. Supply Voltage



SUITABLE DATA FORMAT

The TSOP753.., TSOP755.. series are designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP753.. and TSOP755.. in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated pattern from fluorescent lamps with electronic ballasts (see fig. 14 or fig. 15)

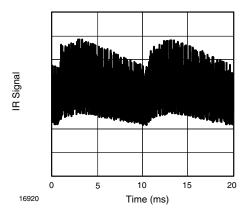


Fig. 14 - IR Discturbance from Fluorescent Lamp with Low Modulation

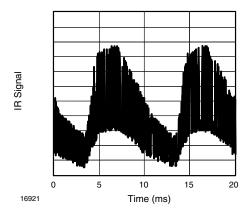


Fig. 15 - IR Discturbance from Fluorescent Lamp with High Modulation

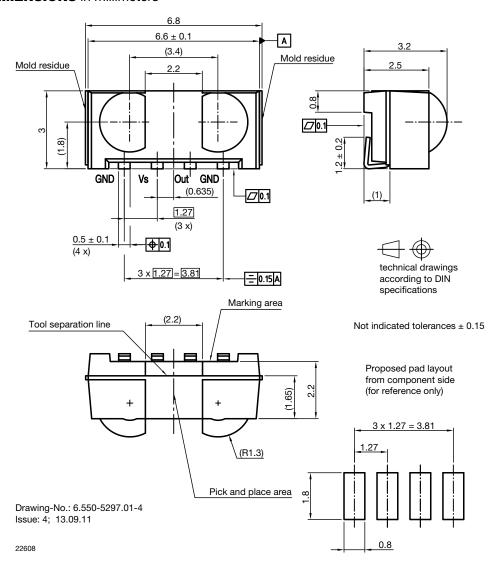
	TSOP753	TSOP755
Minimum burst length	6 cycles/burst	6 cycles/burst
After each burst of length a minimum gap time is required of	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	35 cycles > 4 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	2000	2000
MCIR code	preferred	yes
RCMM code	preferred	yes
XMP-1, XMP-2 code	preferred	yes
Suppression of interference from fluorescent lamps	Most common disturbance patterns are suppressed	Most common disturbance patterns are suppressed

Notes

- For data formats with long bursts please see the datasheet for TSOP752.., TSOP754..
- Best choice of AGC for some popular IR-codes:
 - TSOP75336: MCIR, RCMM
 - TSOP75538: Mitsubishi, RECS-80 Code
 - TSOP75338: XMP-1, XMP-2, r-map
- For SIRCS 15 and 20 bit, Sony 12 bit IR-codes, please see the datasheet for TSOP75S40F



PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

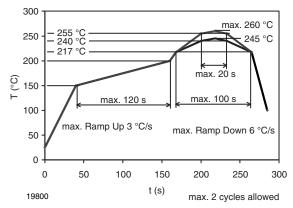
Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Excercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

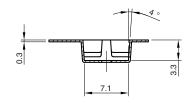
Manual Soldering

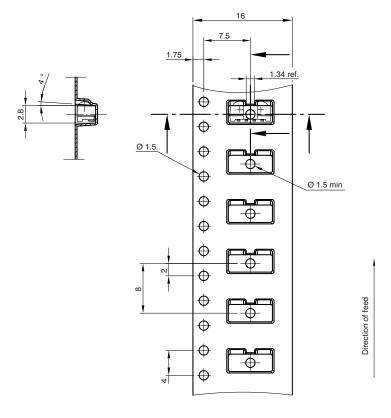
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TR DIMENSIONS in millimeters





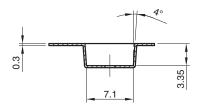
technical drawings according to DIN specifications

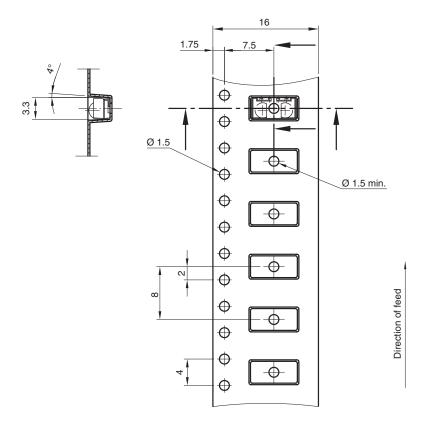
Drawing-No.: 9.700-5337.01-4

Issue: 1; 16.10.08

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TAPING VERSION TSOP..TT DIMENSIONS in millimeters



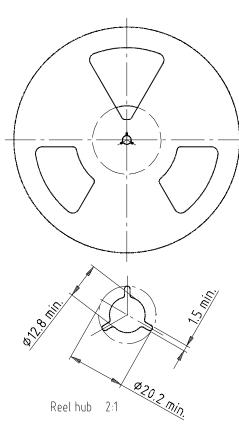


technical drawings

technical drawings according to DIN specifications

Drawing-No.: 9.700-5338.01-4 Issue: 3; 09.06.09 ²¹⁵⁷⁸

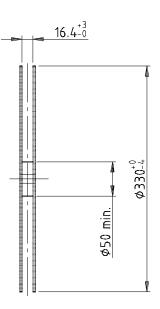
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734



Form of the leave open of the wheel is supplier specific.

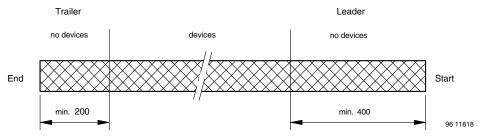
Dimension acc. to IEC EN 60 286-3

Tape width 16



specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

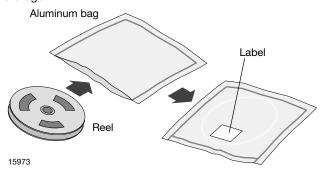
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.



VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (Finished goods				
PLAIN WRITING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	xxxxxxx+	Company logo		
LONG BAR CODE TOP	TYPE	LENGTH		
Item-number	N	8		
Plant-code	N	2		
Sequence-number	X	3		
Quantity	N	8		
Total length	-	21		
SHORT BAR CODE BOTTOM	TYPE	LENGTH		
Selection-code	X	3		
Data-code	N	3		
Batch-number	Х	10		
Filter	-	1		
Total length	-	17		

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

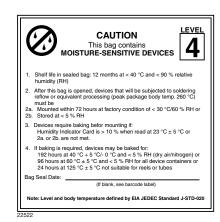
After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 $^{\circ}$ C + 5 $^{\circ}$ C / - 0 $^{\circ}$ C and < 5 $^{\circ}$ RH (dry air/nitrogen)

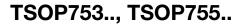
96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags





ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data

BAR CODE PRODUCT LABEL (Example)



22178



Legal Disclaimer Notice

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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

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